

Lead free solder paste 500g, Sn96,5Ag3Cu0,5



- Solder paste NO-CLEAN
- TLF-204-171AK
- Grain size 4 (25-36 µm)

Item no.	WL42942
Model	Pastentyp AP-60-T
Manufacturer	TAMURA ELSOLD
Manufacturer article no.	LOTPAST8003
GPSR manufacturer data	TAMURA DEUTSCHLAND GmbH Hüttenstraße 1 DE-38871 Ilseburg www.tamura-elsold.de
Sales unit	1 cans

Products for the electronic industry



Content unit	500 g
Detail content unit	500 g
Incl. battery	no
Classification	ROLO
Alloy	Sn96,5Ag3Cu0,5
Lead-free/lead-containing	lead free
Metal content	88.5 %

